

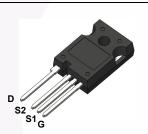
FCH023N65S3L4 N-Channel SuperFET[®] III MOSFET 650 V, 75 A, 23 mΩ

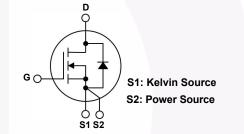
Features

- 700 V @ T_J = 150°C
- Typ. R_{DS(on)} = 19.5 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 222 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 1980 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- Telecom / Server Power Supplies
 UPS / Solar
- Industrial Power Supply





SuperFET[®] III MOSFET is Fairchild Semiconductor's brandnew high voltage super-junction (SJ) MOSFET family that is uti-

lizing charge balance technology for outstanding low on-resis-

tance and lower gate charge performance. This advanced

technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt

rate. Consequently, SuperFET III MOSFET is suitable for vari-

ous DC/AC power conversion for system miniaturization and

Description

higher efficiency.

Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCH023N65S3L4	Unit	
V _{DSS}	Drain to Source Voltage	e		650	V	
V _{GSS}	Gate to Source Voltage	- DC	- DC		V	
		- AC	(f > 1 Hz)	±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		75	•	
		- Continuous (T _C = 100 ^o C)		65.8	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	300	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2025	mJ		
I _{AR}	Avalanche Current (Note 1)		15	Α		
E _{AR}	Repetitive Avalanche Energy (Note 1)		5.95	mJ		
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20	v/ns	
P _D	Dawar Dissinction	(T _C = 25 ^o C)		595	W	
	Power Dissipation	- Derate Above 25°C		4.76	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C		
Τ _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C		

Thermal Characteristics

Symbol	Parameter	FCH023N65S3L4	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

June 2016

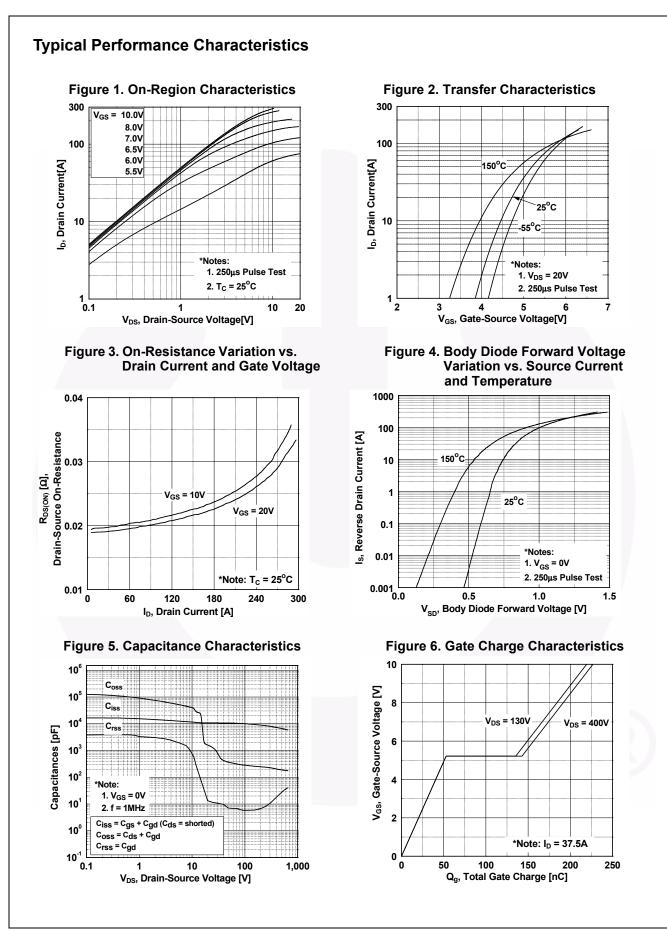
Part Number Top Mark Pag		Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity	
FCH023N6			TO-247 A04	Tube	N/A		N/A	30 units	
Electrica	l Char	acteristics T _c =	25°C unless of	otherwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C		650	-	-	V
BV _{DSS}			oitage	V _{GS} = 0 V, I _D = 1 mA, T _J = 150°C		700	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		ure	$I_D = 1 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$		-	0.72	-	V/ºC
	Zero G	ate Voltage Drain Curre	ont	V_{DS} = 650 V, V_{GS} = 0	V	-	-	1	μA
DSS	2610 04		SIIC	V _{DS} = 520 V, T _C = 125	5°C	-	6.8	-	μΛ
GSS	Gate to Body Leakage Current		ıt	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charac	teristic	S							
V _{GS(th)}	Gate TI	nreshold Voltage		V _{GS} = V _{DS} , I _D = 7.5 m	A	2.5	-	4.5	V
R _{DS(on)}	Static D	rain to Source On Res	sistance	V _{GS} = 10 V, I _D = 37.5		-	19.5	23	mΩ
JFS	Forwar	d Transconductance		V _{DS} = 20 V, I _D = 37.5 A		-	66	-	S
Dynamic C	haracte	eristics							
C _{iss}	Input C	Input Capacitance		V _{DS} = 400 V, V _{GS} = 0 V,		-	7160	-	pF
C _{oss}	Output	utput Capacitance		f = 1 MHz		-	195	-	pF
C _{oss(eff.)}	Effective Output Capacitance			V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	1980	-	pF
C _{oss(er.)}	Energy Related Output Capacitance		itance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	298	-	
Q _{g(tot)}		ate Charge at 10V		V _{DS} = 400 V, I _D = 37.	5 A,	-	222	-	nC
Q _{gs}		Source Gate Charge		V _{GS} = 10 V		-	54	-	nC
Q _{gd}		Drain "Miller" Charge			(Note 4)	-	90	-	nC
	Equival	ent Series Resistance		f = 1 MHz		-	0.9	-	Ω
ESR	~	teristics							
-	Charac					-	43	-	ns
Switching		n Delay Time	-					-	ns
Switching	Turn-Or		_	V _{DD} = 400 V, I _D = 37.5	5 A,	-	30	-	ns
Switching	Turn-Or Turn-Or	n Delay Time		V _{DD} = 400 V, I _D = 37.5 V _{GS} = 10 V, R _g = 2 Ω	5 A,		30 130	-	110
Switching t _{d(on)} t _r	Turn-Or Turn-Or Turn-Of	n Delay Time n Rise Time			5 A, (Note 4)	•			ns
Switching	Turn-Or Turn-Or Turn-Of Turn-Of	n Delay Time n Rise Time f Delay Time	 		-	-	130	-	
Switching d(on) r d(off) f Drain-Soul	Turn-Or Turn-Or Turn-Of Turn-Of	n Delay Time n Rise Time f Delay Time f Fall Time		V _{GS} = 10 V, R _g = 2 Ω	-	-	130	-	
Switching d(on) r d(off) f Drain-Sour s	Turn-Or Turn-Of Turn-Of Turn-Of	n Delay Time n Rise Time f Delay Time f Fall Time de Characteristic	Source Diode	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 2 \Omega$ e Forward Current	-	- - -	130	-	ns
Switching td(on) tr td(off) tf Drain-Sour s SM	Turn-Or Turn-Of Turn-Of Turn-Of Ce Dioo Maximu Maximu	n Delay Time n Rise Time f Delay Time f Fall Time de Characteristic m Continuous Drain to	Source Diode	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 2 \Omega$ e Forward Current	(Note 4)	- - -	130	- - 75	ns A
Switching t _{d(on)} t _r t _{d(off)} t _f	Turn-Or Turn-Or Turn-Of Turn-Of CCE Dioo Maximu Maximu Drain to	n Delay Time n Rise Time f Delay Time f Fall Time de Characteristic m Continuous Drain to m Pulsed Drain to Sou	Source Diode	V_{GS} = 10 V, R_g = 2 Ω Forward Current ward Current	(Note 4)	- - - - -	130	- - 75 300	ns A A

1. Repetitive rating: pulse width limited by maximum junction temperature.

2. I_{AS} = 15 A, R_G = 25 Ω , starting T_J = 25°C.

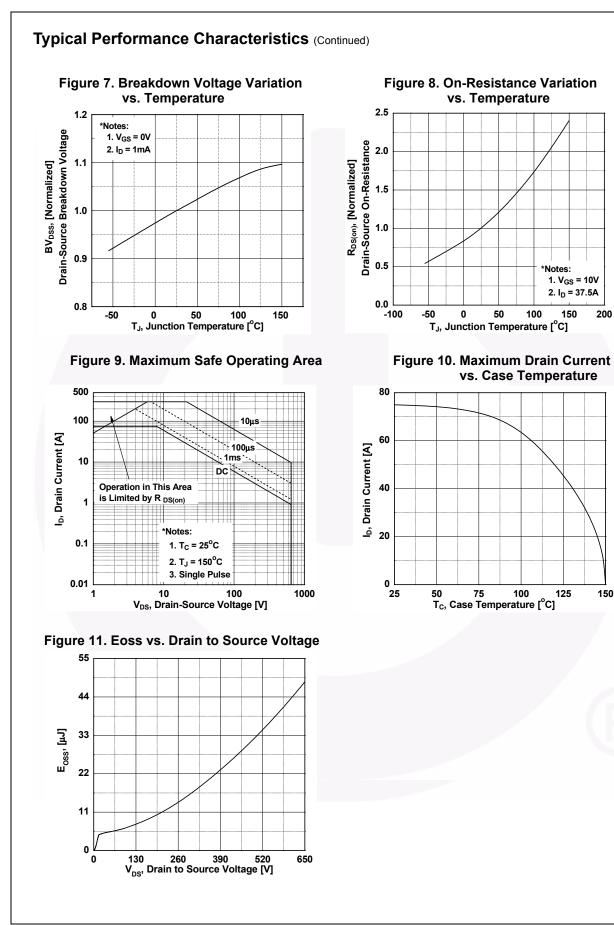
3. I_{SD} \leq 75 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

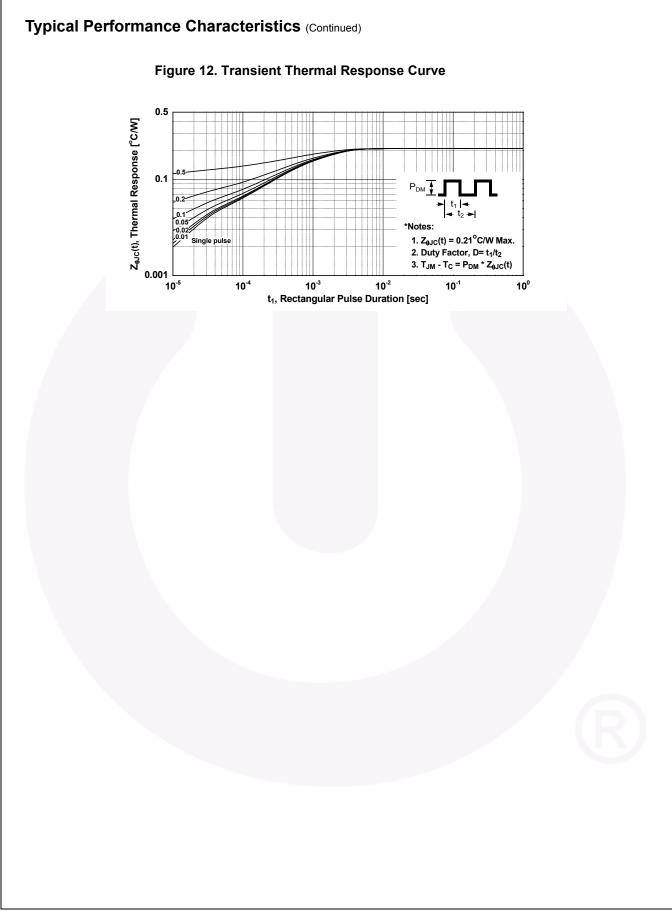
4. Essentially independent of operating temperature typical characteristics.

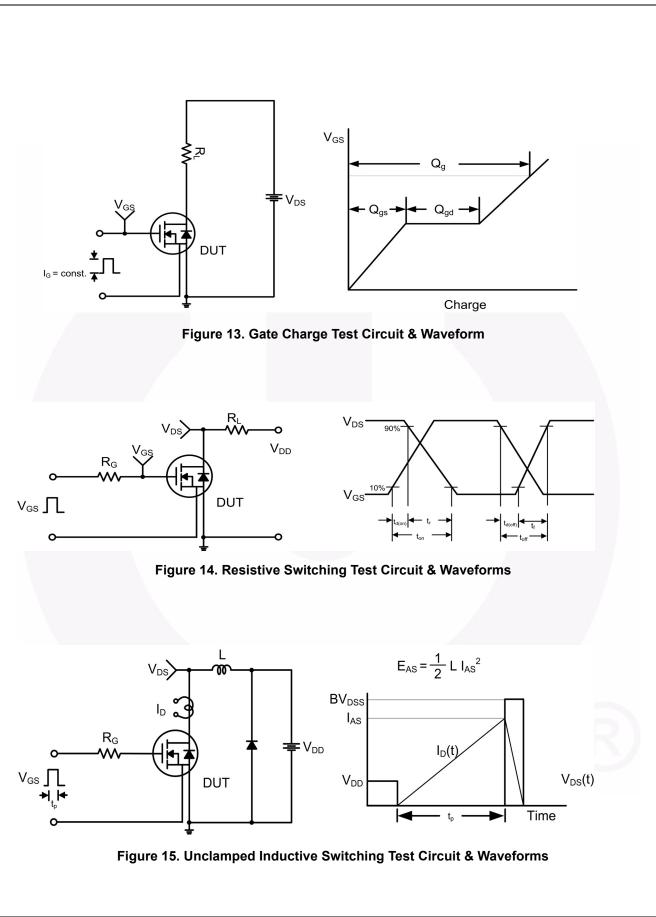


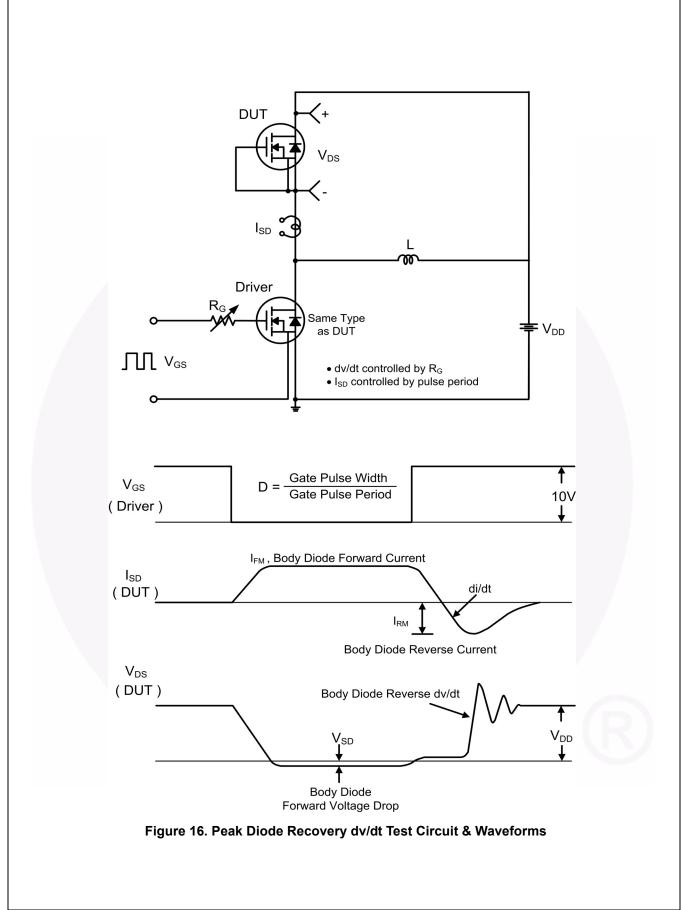
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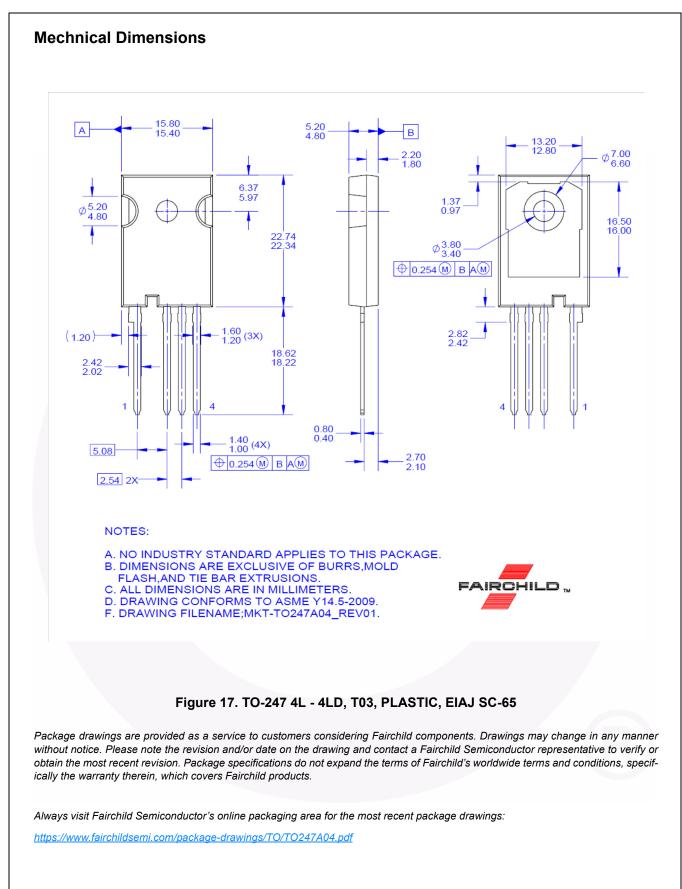














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